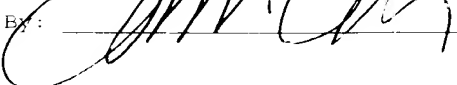




OR 99 P 5374

BOX AF

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231

By: 

Date: March 4, 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Nicolas Nagel et al.

Applic. No. : 09/729,069

Filed : December 4, 2000

Title : Microelectronic Structure and Method of  
Fabricating it

Examiner : David Vu

Group Art Unit : 2818

A M E N D M E N T under 37 C.F.R. § 1.116

BOX AF  
Hon. Commissioner of Patents and Trademarks,  
Washington, D. C. 20231

S i r :

Responsive to the final Office action dated December 4, 2002  
kindly amend the above-identified application as follows:

In the Claims:

Cancel claims 3, 11 and 13.

Claim 1(twice amended). A microelectronic structure,  
comprising:

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